

# Enhancement Mode pHEMT Technology (E-pHEMT) Low Noise Amplifier

The MML20242H is a 2-stage low noise amplifier (LNA) with active bias and high isolation for use in cellular infrastructure applications. It is designed for a range of low noise, high linearity applications such as picocell, femtocell, tower mounted amplifiers (TMA) and receiver front-end circuits. It operates from a single voltage supply and is suitable for applications with frequencies from 1400 to 2800 MHz such as TD-SCDMA, W-CDMA, UMTS, PCS, LTE and BWA.

## Features

- Low Noise Figure: 0.59 dB @ 1950 MHz
- Frequency: 1400–2800 MHz
- Unconditionally Stable over Temperature
- High Reverse Isolation: -51 dB @ 1950 MHz
- P1dB: 24 dBm @ 1950 MHz
- Small-Signal Gain: 34 dB @ 1950 MHz
- Third Order Output Intercept Point: 39.5 dBm @ 1950 MHz
- Active Bias Control (adjustable externally)
- Single 5 V Supply
- Supply Current: 160 mA
- 50 Ohm Operation (some external matching required)
- Cost-effective 12-pin, 3 mm QFN Surface Mount Plastic Package
- In Tape and Reel. T1 Suffix = 1,000 Units, 12 mm Tape Width, 7-inch Reel.

**MML20242HT1**

**1400–2800 MHz, 34 dB  
24 dBm, 0.59 dB NF  
E-pHEMT LNA**



**QFN 3 x 3**

**Table 1. Typical Performance (1)**

| Characteristic                     | Symbol         | 1400 MHz | 1950 MHz | 2800 MHz | Unit |
|------------------------------------|----------------|----------|----------|----------|------|
| Noise Figure (2)                   | NF             | 0.55     | 0.59     | 0.97     | dB   |
| Input Return Loss (S11)            | IRL            | -15      | -18      | -18      | dB   |
| Output Return Loss (S22)           | ORL            | -14      | -15      | -15      | dB   |
| Small-Signal Gain (S21)            | G <sub>p</sub> | 38       | 34       | 31.5     | dB   |
| Power Output @ 1dB Compression     | P1dB           | 23.5     | 24       | 24       | dBm  |
| Third Order Input Intercept Point  | IIP3           | 1        | 5.5      | 8        | dBm  |
| Third Order Output Intercept Point | OIP3           | 39       | 39.5     | 39.5     | dBm  |

1. V<sub>DD</sub> = 5 Vdc, T<sub>A</sub> = 25°C, 50 ohm system, application circuit tuned for specified frequency.

2. Noise figure value calculated with connector losses removed.

**Table 2. Maximum Ratings**

| Rating                    | Symbol           | Value       | Unit |
|---------------------------|------------------|-------------|------|
| Supply Voltage            | V <sub>DD</sub>  | 6           | V    |
| Supply Current            | I <sub>DD</sub>  | 300         | mA   |
| RF Input Power (3)        | P <sub>in</sub>  | 28          | dBm  |
| Storage Temperature Range | T <sub>stg</sub> | -65 to +150 | °C   |
| Junction Temperature      | T <sub>J</sub>   | 175         | °C   |

3. Measured using CW test signal.

**Table 3. Thermal Characteristics**

| Characteristic  | Symbol           | Value (4) | Unit |
|---|------------------|-----------|------|
| Thermal Resistance, Junction to Case<br>Case Temperature 95°C, 5 Vdc, 163 mA, no RF applied | R <sub>θJC</sub> | 40        | °C/W |

4. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.

**Table 4. Electrical Characteristics** ( $V_{DD} = 5 \text{ Vdc}$ , 2140 MHz,  $T_A = 25^\circ\text{C}$ , 50 ohm system, in Freescale Application Circuit)

| Characteristic                     | Symbol   | Min  | Typ  | Max | Unit |
|------------------------------------|----------|------|------|-----|------|
| Small-Signal Gain (S21)            | $G_p$    | 30.6 | 32.5 | —   | dB   |
| Input Return Loss (S11)            | IRL      | —    | -18  | —   | dB   |
| Output Return Loss (S22)           | ORL      | —    | -15  | —   | dB   |
| Power Output @ 1dB Compression     | P1dB     | —    | 24   | —   | dBm  |
| Third Order Input Intercept Point  | IIP3     | —    | 7    | —   | dBm  |
| Third Order Output Intercept Point | OIP3     | —    | 39.5 | —   | dBm  |
| Reverse Isolation (S12)            | S12      | —    | -50  | —   | dBm  |
| Noise Figure <sup>(1)</sup>        | NF       | —    | 0.7  | —   | dB   |
| Supply Current <sup>(2)</sup>      | $I_{DD}$ | 117  | 160  | 207 | mA   |
| Supply Voltage                     | $V_{DD}$ | —    | 5    | —   | V    |

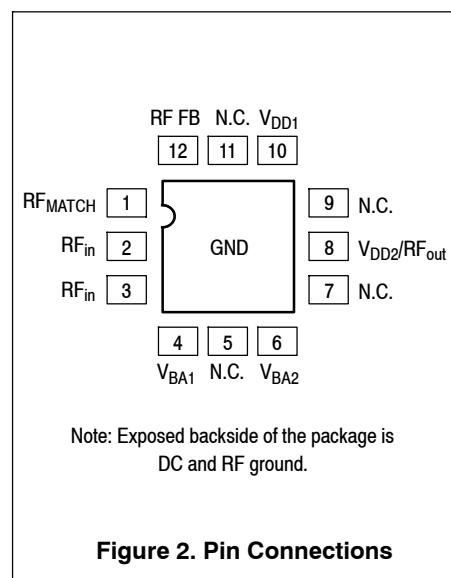
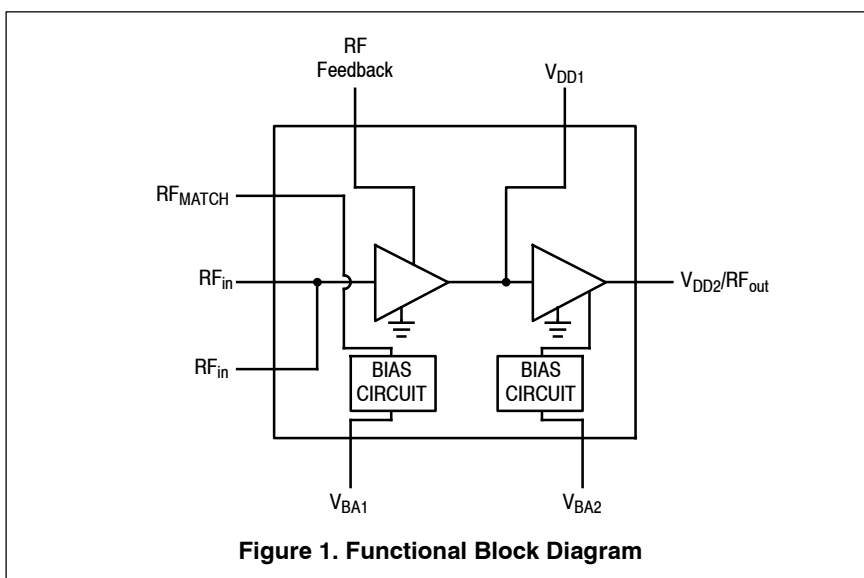
**Table 5. ESD Protection Characteristics**

| Test Methodology                      | Class |
|---------------------------------------|-------|
| Human Body Model (per JESD22-A114)    | 0     |
| Machine Model (per EIA/JESD22-A115)   | A     |
| Charge Device Model (per JESD22-C101) | IV    |

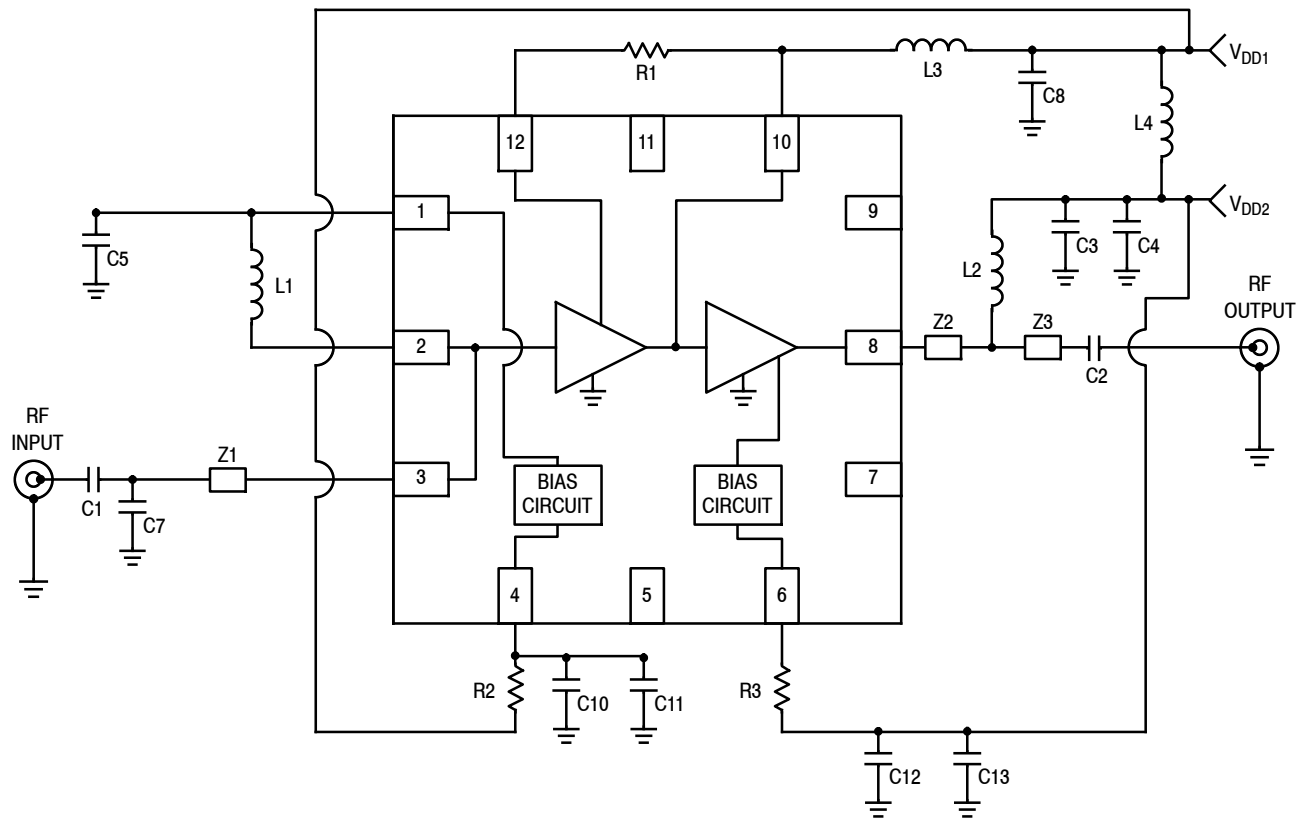
**Table 6. Moisture Sensitivity Level**

| Test Methodology                     | Rating | Package Peak Temperature | Unit             |
|--------------------------------------|--------|--------------------------|------------------|
| Per JESD22-A113, IPC/JEDEC J-STD-020 | 1      | 260                      | $^\circ\text{C}$ |

1. Noise figure value calculated with connector losses removed.
2. DC current measured with no RF signal applied.



### 50 OHM APPLICATION CIRCUIT: 1950 MHz



- Z1 0.248" × 0.021" Microstrip
- Z2 0.050" × 0.021" Microstrip
- Z3 0.030" × 0.021" Microstrip

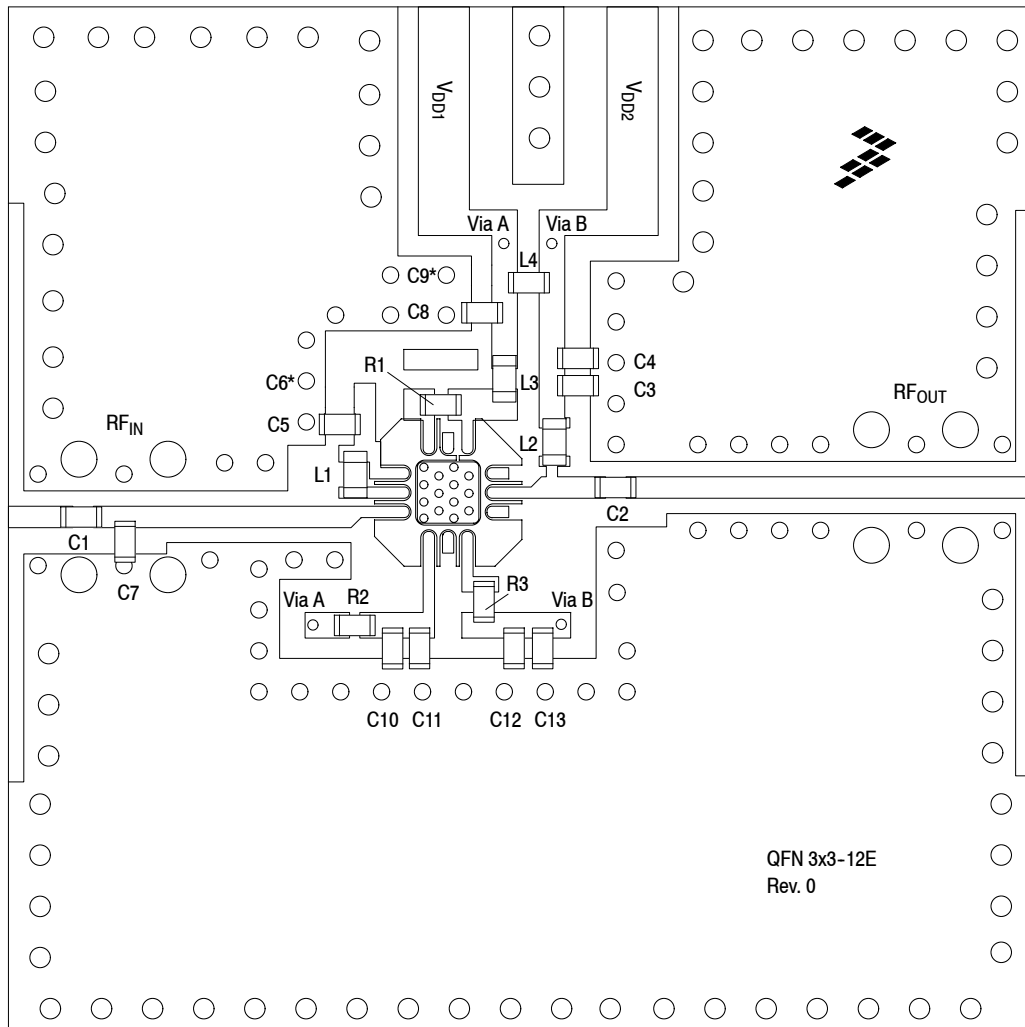
**Figure 3. MML20242HT1 Test Circuit Schematic**

**Table 7. MML20242HT1 Test Circuit Component Designations and Values**

| Part                 | Description                               | Part Number       | Manufacturer |
|----------------------|---|-------------------|--------------|
| C1, C5               | 18 pF Chip Capacitors                     | GJM1555C1H180GB01 | Murata       |
| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                     | GRM1555C1H180JA01 | Murata       |
| C4, C10, C13         | 0.1 μF Chip Capacitors                    | GRM155R61A104K01  | Murata       |
| C6, C9               | Components Not Placed                     |                   |              |
| C7                   | 0.6 pF Chip Capacitor                     | GJM1555C1HR60WB01 | Murata       |
| L1                   | 3.3 nH Chip Inductor                      | 0402HP-3N3XJLW    | Coilcraft    |
| L2, L4               | 10 nH Chip Inductors                      | 0402CS-10NXJLW    | Coilcraft    |
| L3                   | 2.2 nH Chip Inductor                      | 0402CS-2N2XJLW    | Coilcraft    |
| R1                   | 180 Ω Chip Resistor                       | RC0402FR-07-180RL | Yageo        |
| R2, R3               | 1200 Ω Chip Resistors                     | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", ε <sub>r</sub> = 3.48, Multilayer | RO4350B           | Rogers       |

Note: Component numbers C6 and C9 are labeled on board but not placed.

### 50 OHM APPLICATION CIRCUIT: 1950 MHz



Note: Component numbers C6\* and C9\* are labeled on board but not placed.

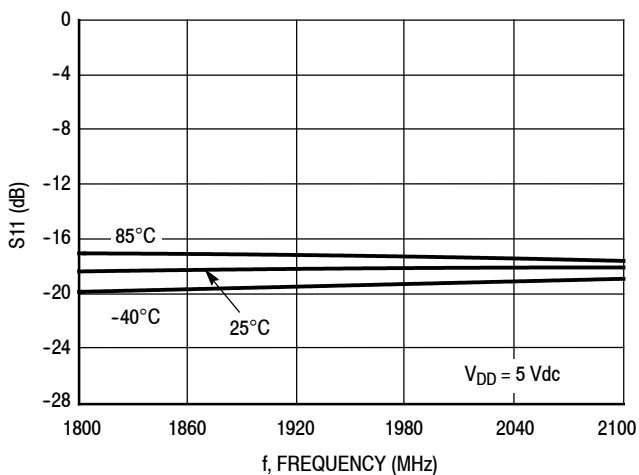
**Figure 4. MML20242HT1 Test Circuit Component Layout**

**Table 7. MML20242HT1 Test Circuit Component Designations and Values**

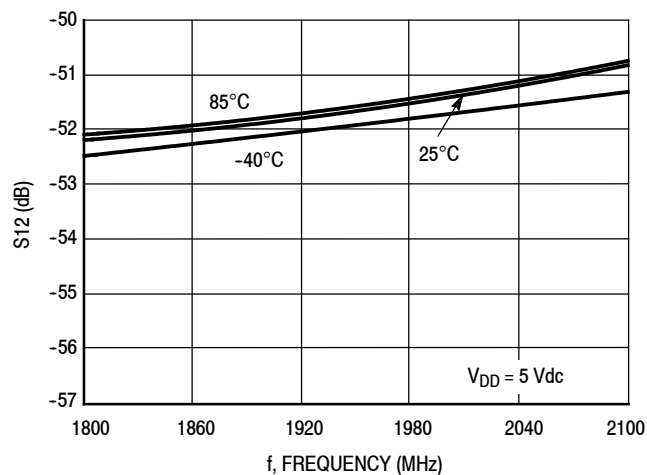
| Part                 | Description                              | Part Number       | Manufacturer |
|----------------------|--|-------------------|--------------|
| C1, C5               | 18 pF Chip Capacitors                    | GJM1555C1H180GB01 | Murata       |
| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                    | GRM1555C1H180JA01 | Murata       |
| C4, C10, C13         | 0.1 $\mu$ F Chip Capacitors              | GRM155R61A104K01  | Murata       |
| C6, C9               | Components Not Placed                    |                   |              |
| C7                   | 0.6 pF Chip Capacitor                    | GJM1555C1HR60WB01 | Murata       |
| L1                   | 3.3 nH Chip Inductor                     | 0402HP-3N3XJLW    | Coilcraft    |
| L2, L4               | 10 nH Chip Inductors                     | 0402CS-10NXJLW    | Coilcraft    |
| L3                   | 2.2 nH Chip Inductor                     | 0402CS-2N2XJLW    | Coilcraft    |
| R1                   | 180 $\Omega$ Chip Resistor               | RC0402FR-07-180RL | Yageo        |
| R2, R3               | 1200 $\Omega$ Chip Resistors             | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", $\epsilon_r = 3.48$ , Multilayer | RO4350B           | Rogers       |

(Test Circuit Component Designations and Values repeated for reference.)

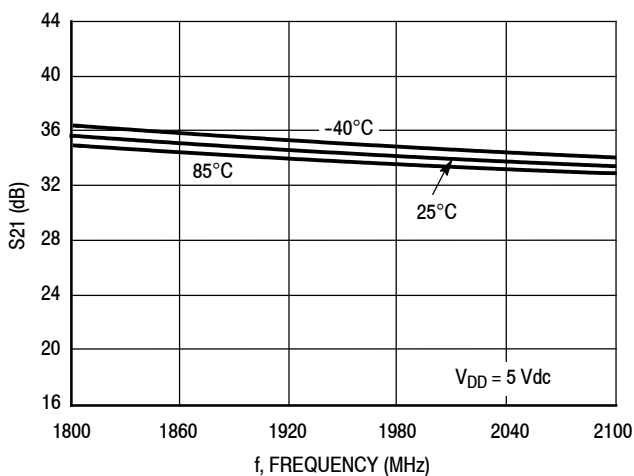
### 50 OHM TYPICAL CHARACTERISTICS: 1950 MHz



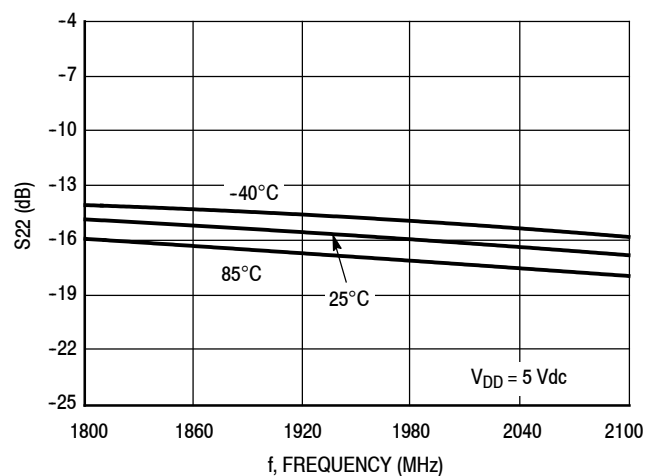
**Figure 5. S11 versus Frequency versus Temperature**



**Figure 6. S12 versus Frequency versus Temperature**

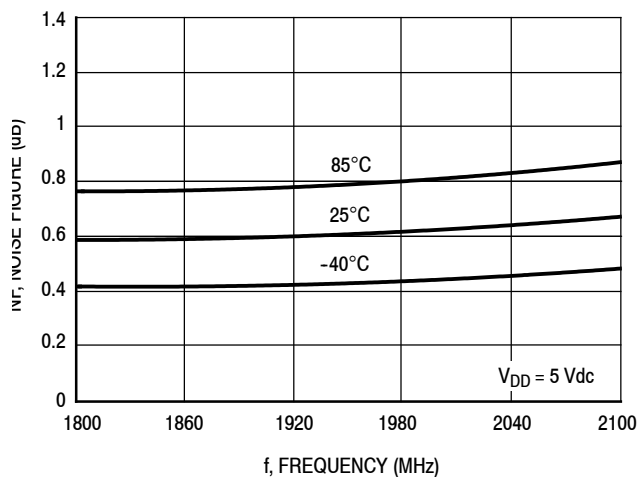


**Figure 7. S21 versus Frequency versus Temperature**

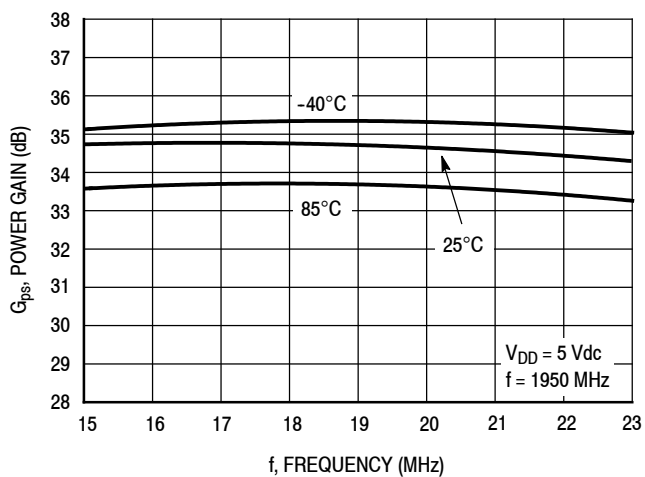


**Figure 8. S22 versus Frequency versus Temperature**

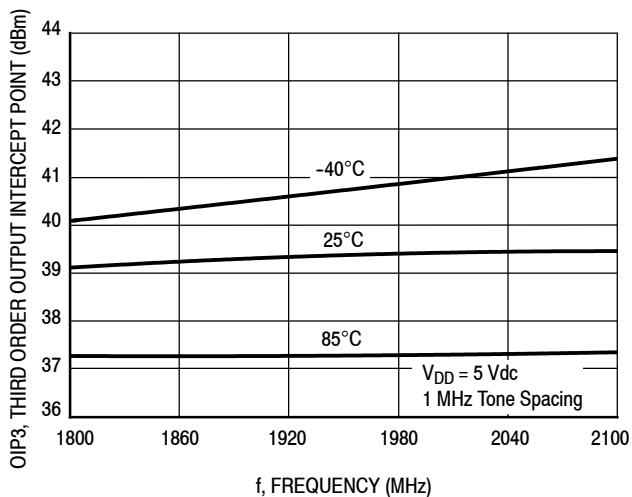
### 50 OHM TYPICAL CHARACTERISTICS: 1950 MHz



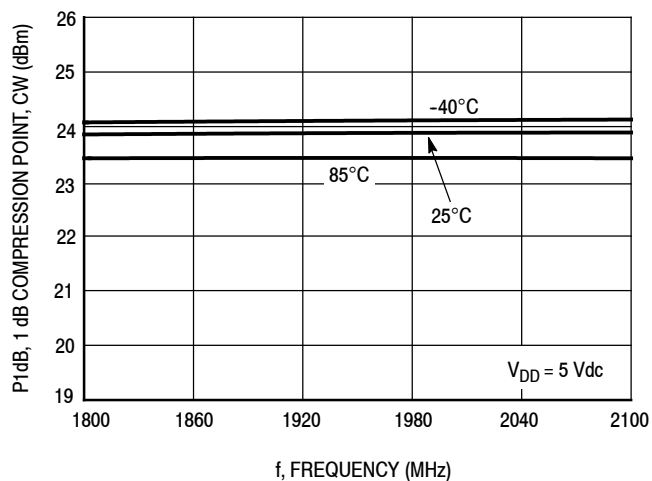
**Figure 9. Noise Figure versus Frequency versus Temperature**



**Figure 10. Power Gain versus Output Power versus Temperature, CW**

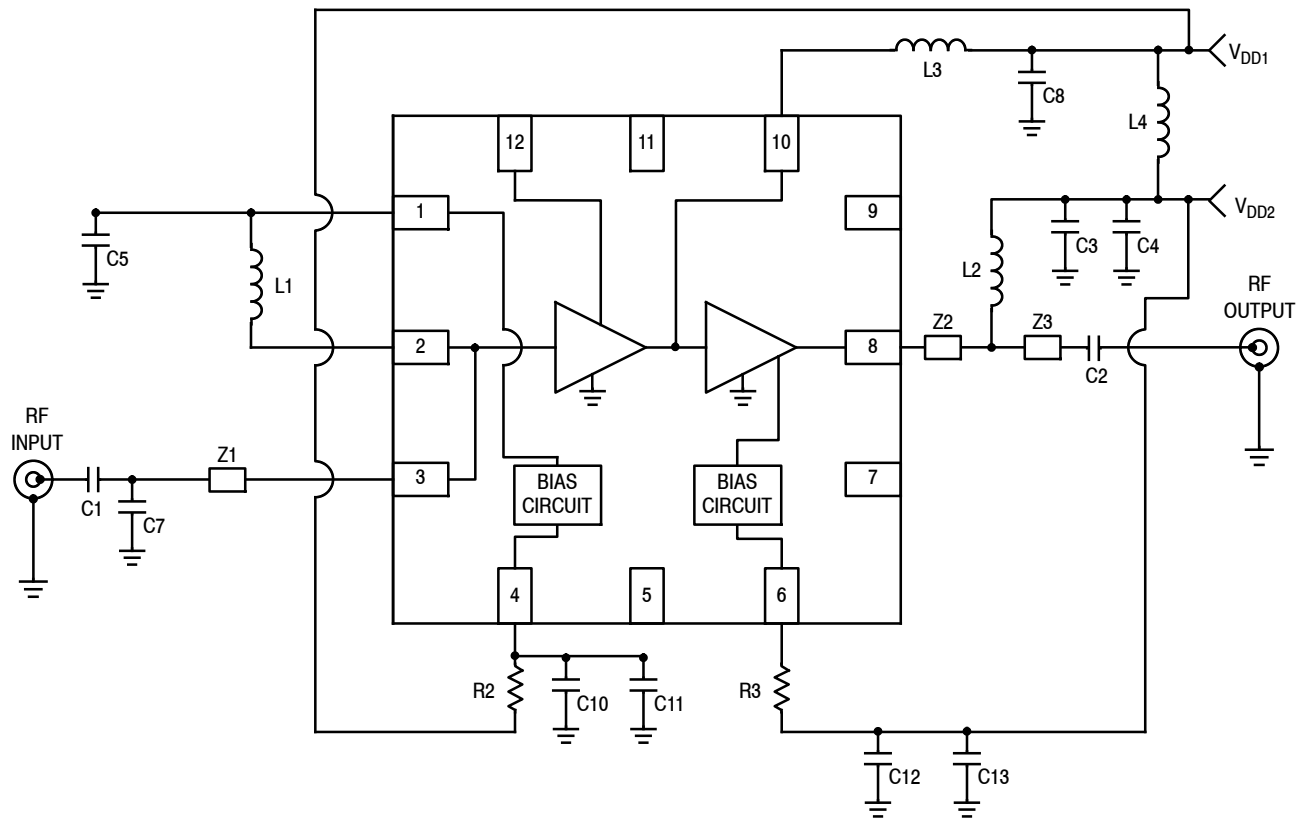


**Figure 11. Third Order Output Intercept Point (Two-Tone) versus Frequency versus Temperature**



**Figure 12. P1dB versus Frequency versus Temperature, CW**

### 50 OHM APPLICATION CIRCUIT: 2535 MHz



- Z1 0.248" × 0.021" Microstrip
- Z2 0.050" × 0.021" Microstrip
- Z3 0.030" × 0.021" Microstrip

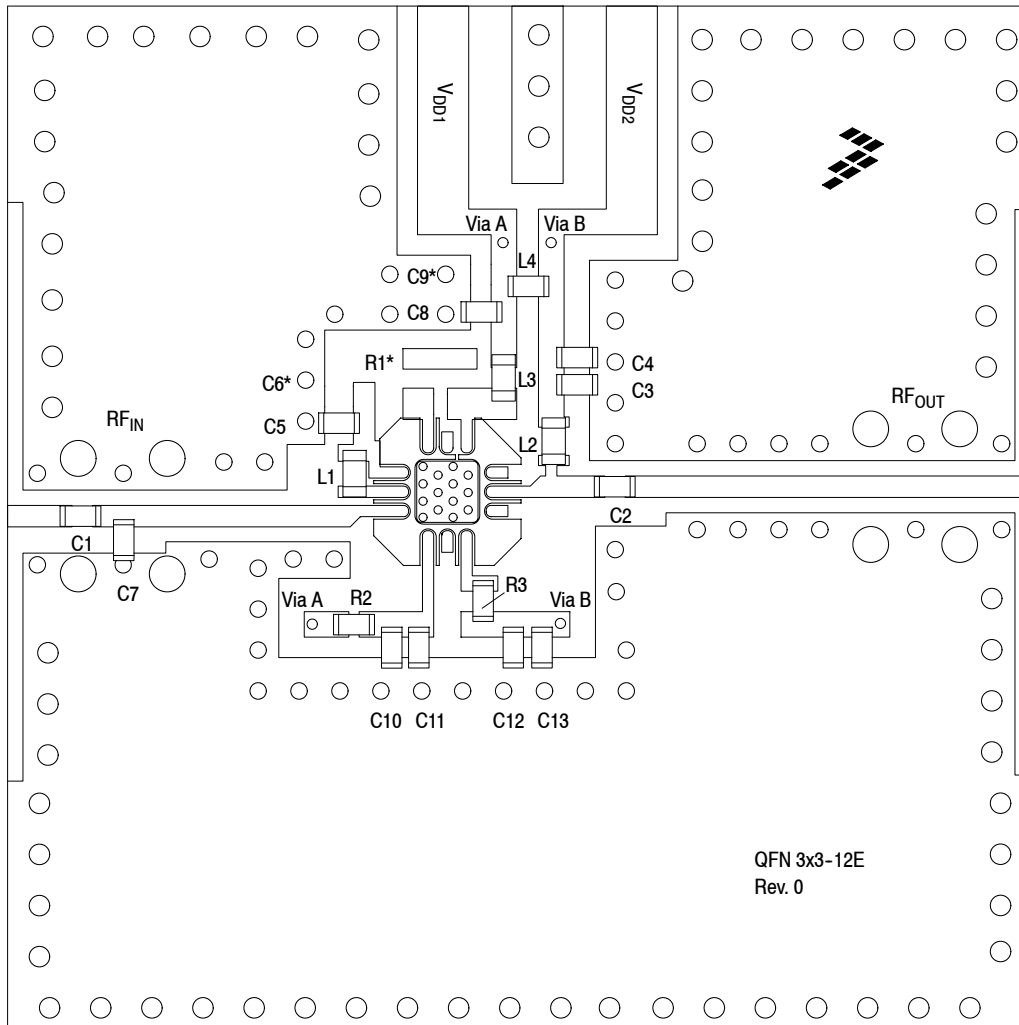
**Figure 13. MML20242HT1 Test Circuit Schematic**

**Table 8. MML20242HT1 Test Circuit Component Designations and Values**

| Part                 | Description                              | Part Number       | Manufacturer |
|----------------------|--|-------------------|--------------|
| C1, C5               | 18 pF Chip Capacitors                    | GJM1555C1H180GB01 | Murata       |
| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                    | GRM1555C1H180JA01 | Murata       |
| C4, C10, C13         | 0.1 $\mu$ F Chip Capacitors              | GRM155R61A104K01  | Murata       |
| C6, C9               | Components Not Placed                    |                   |              |
| C7                   | 0.6 pF Chip Capacitor                    | GJM1555C1HR60WB01 | Murata       |
| L1                   | 2.7 nH Chip Inductor                     | 0402HP-2N7XJLW    | Coilcraft    |
| L2, L4               | 6.8 nH Chip Inductors                    | 0402CS-6N8XJLW    | Coilcraft    |
| L3                   | 1.0 nH Chip Inductor                     | 0402CS-1N0XJLW    | Coilcraft    |
| R1                   | Component Not Placed                     |                   |              |
| R2, R3               | 1200 $\Omega$ Chip Resistors             | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", $\epsilon_r = 3.48$ , Multilayer | RO4350B           | Rogers       |

Note: Component numbers C6, C9 and R1 are labeled on board but not placed.

### 50 OHM APPLICATION CIRCUIT: 2535 MHz



Note: Component numbers C6\*, C9\* and R1\* are labeled on board but not placed.

**Figure 14. MML20242HT1 Test Circuit Component Layout**

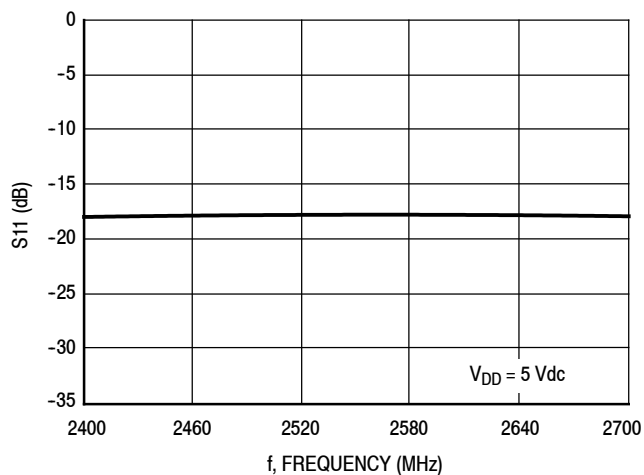
**Table 8. MML20242HT1 Test Circuit Component Designations and Values**

| Part                 | Description                              | Part Number       | Manufacturer |
|----------------------|--|-------------------|--------------|
| C1, C5               | 18 pF Chip Capacitors                    | GJM1555C1H180GB01 | Murata       |
| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                    | GRM1555C1H180JA01 | Murata       |
| C4, C10, C13         | 0.1 $\mu$ F Chip Capacitors              | GRM155R61A104K01  | Murata       |
| C6, C9               | Components Not Placed                    |                   |              |
| C7                   | 0.6 pF Chip Capacitor                    | GJM1555C1HR60WB01 | Murata       |
| L1                   | 2.7 nH Chip Inductor                     | 0402HP-2N7XJLW    | Coilcraft    |
| L2, L4               | 6.8 nH Chip Inductors                    | 0402CS-6N8XJLW    | Coilcraft    |
| L3                   | 1.0 nH Chip Inductor                     | 0402CS-1N0XJLW    | Coilcraft    |
| R1                   | Component Not Placed                     |                   |              |
| R2, R3               | 1200 $\Omega$ Chip Resistors             | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", $\epsilon_r = 3.48$ , Multilayer | RO4350B           | Rogers       |

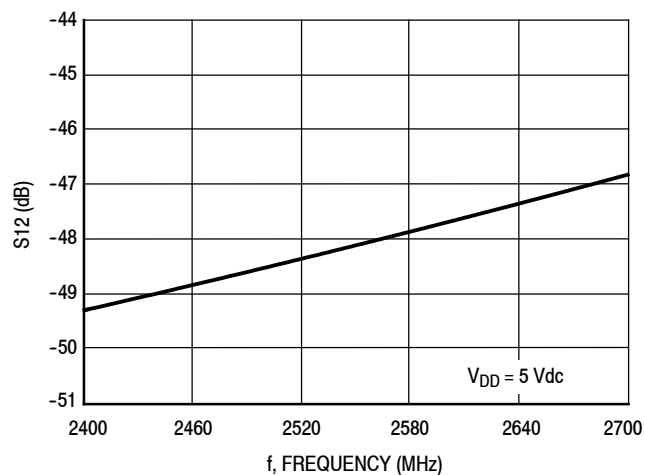
(Test Circuit Component Designations and Values repeated for reference.)



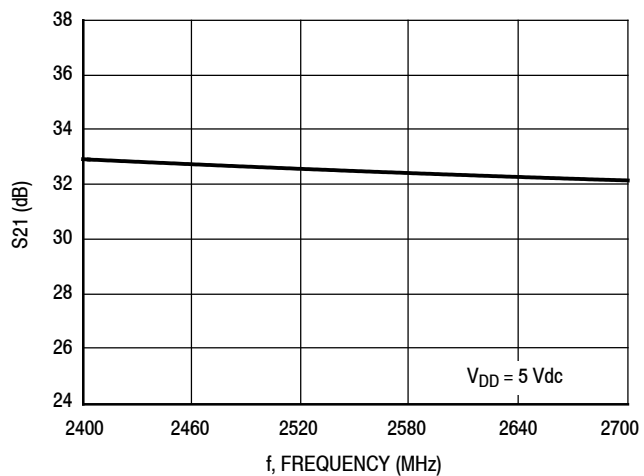
### 50 OHM TYPICAL CHARACTERISTICS: 2535 MHz



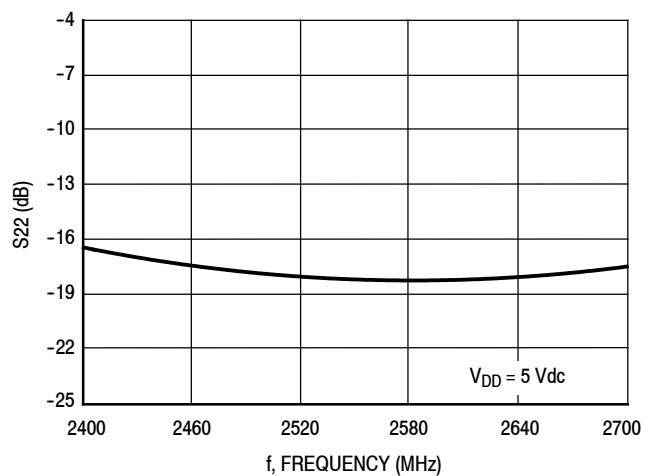
**Figure 15. S11 versus Frequency**



**Figure 16. S12 versus Frequency**



**Figure 17. S21 versus Frequency**



**Figure 18. S22 versus Frequency**

50 OHM TYPICAL CHARACTERISTICS: 2535 MHz

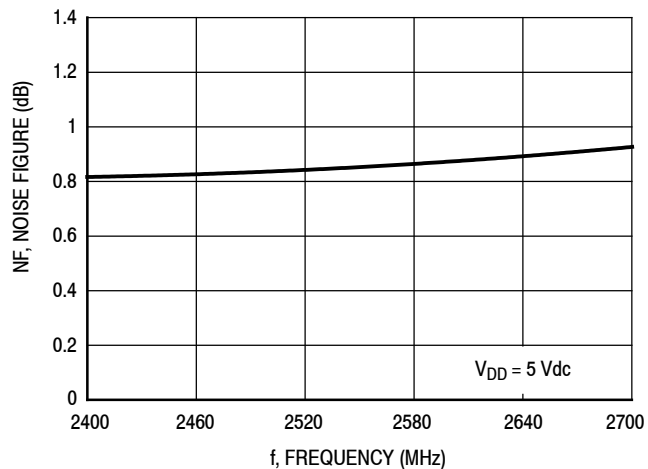


Figure 19. Noise Figure versus Frequency

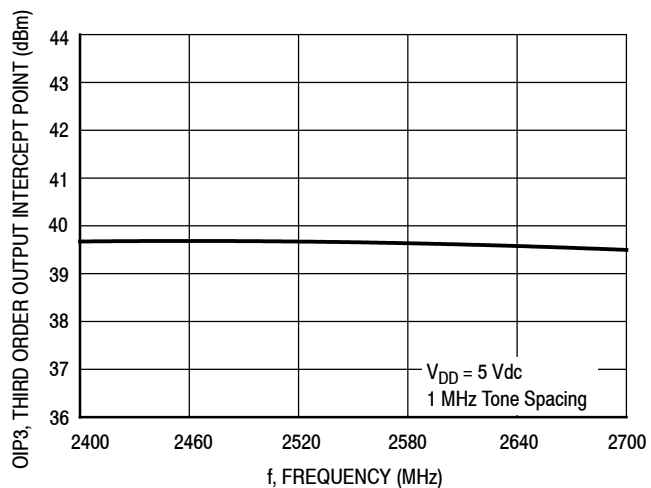


Figure 20. Third Order Output Intercept Point (Two-Tone) versus Frequency

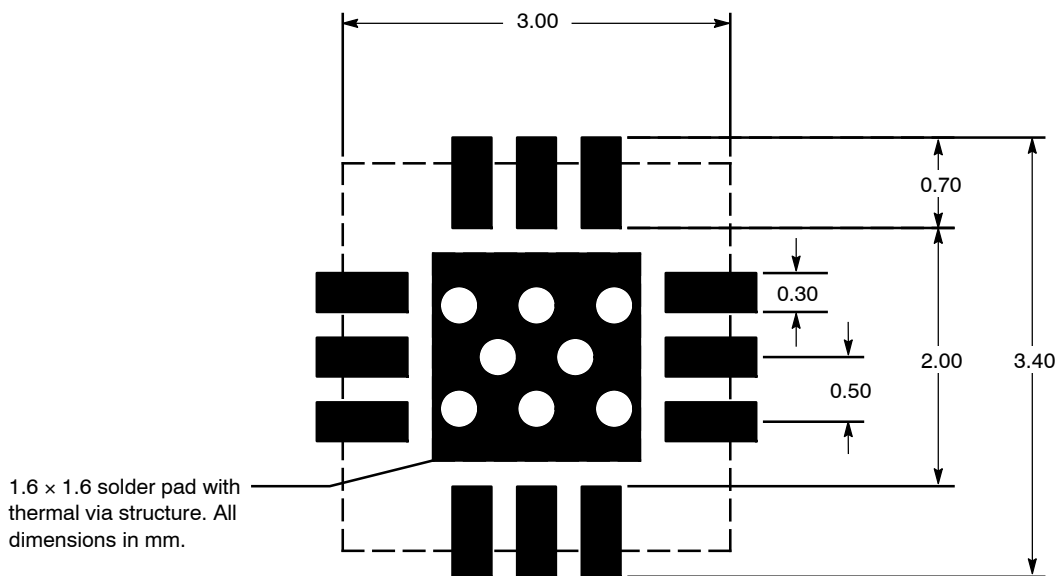
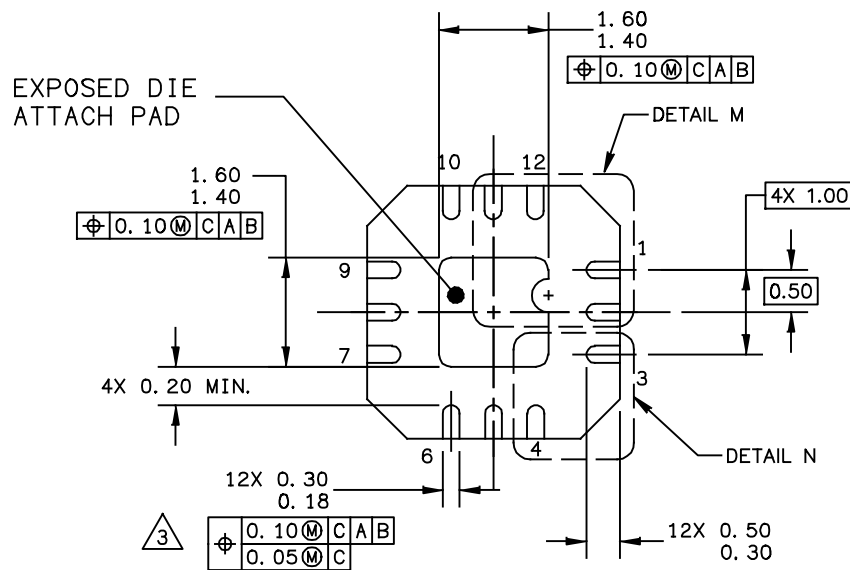
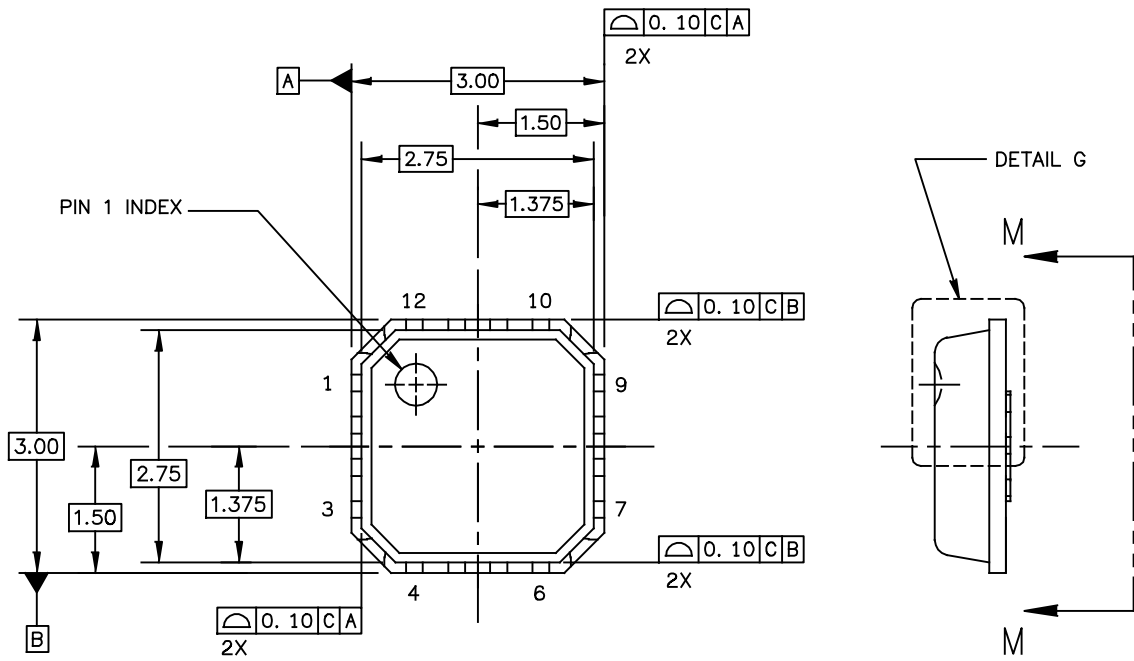


Figure 21. PCB Pad Layout for QFN 3 x 3



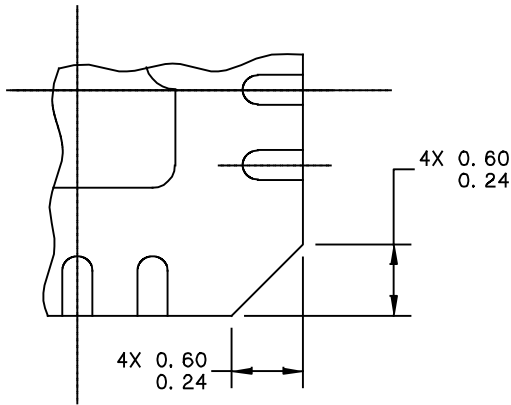
Figure 22. Product Marking

### PACKAGE DIMENSIONS

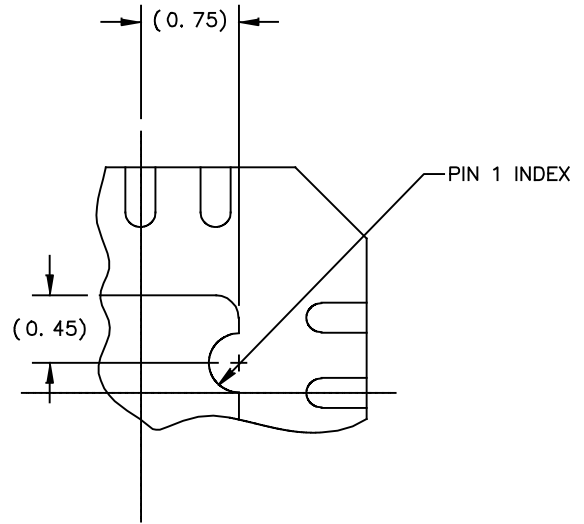


VIEW M-M

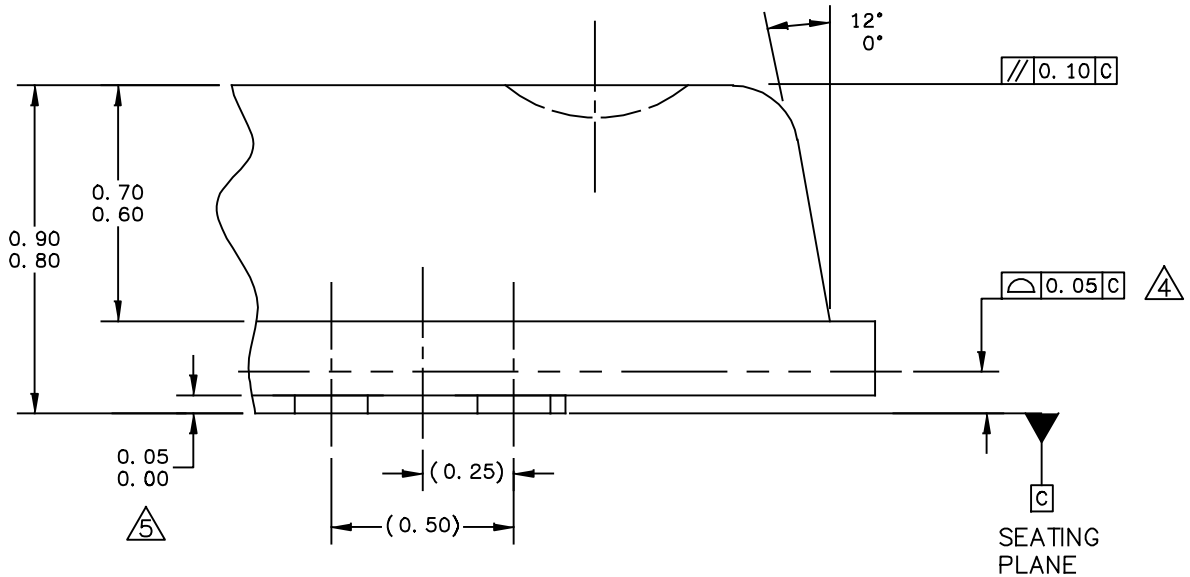
|   |                          |                            |  |
|---|--------------------------|----------------------------|--|
| © FREESCALE SEMICONDUCTOR, INC.<br>ALL RIGHTS RESERVED.   | MECHANICAL OUTLINE       | PRINT VERSION NOT TO SCALE |  |
| TITLE:<br>THERMALLY ENHANCED QUAD<br>FLAT NON-LEADED PACKAGE (QFN)<br>12 TERMINAL, 0.5 PITCH (3X3X0.85) | DOCUMENT NO: 98ASA00227D | REV: 0                     |  |
|   | CASE NUMBER: 2131-01     | 14 MAY 2010                |  |
|   | STANDARD: NON-JEDEC      |                            |  |



DETAIL N  
CORNER CONFIGURATION



DETAIL M  
PIN 1 BACKSIDE INDEX



DETAIL G  
VIEW ROTATED 90° CW

|   |                          |                            |  |
|---|--------------------------|----------------------------|--|
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| TITLE:<br>THERMALLY ENHANCED QUAD<br>FLAT NON-LEADED PACKAGE (QFN)<br>12 TERMINAL, 0.5 PITCH (3X3X0.85) | DOCUMENT NO: 98ASA00227D | REV: 0                     |  |
|   | CASE NUMBER: 2131-01     | 14 MAY 2010                |  |
|   | STANDARD: NON-JEDEC      |                            |  |

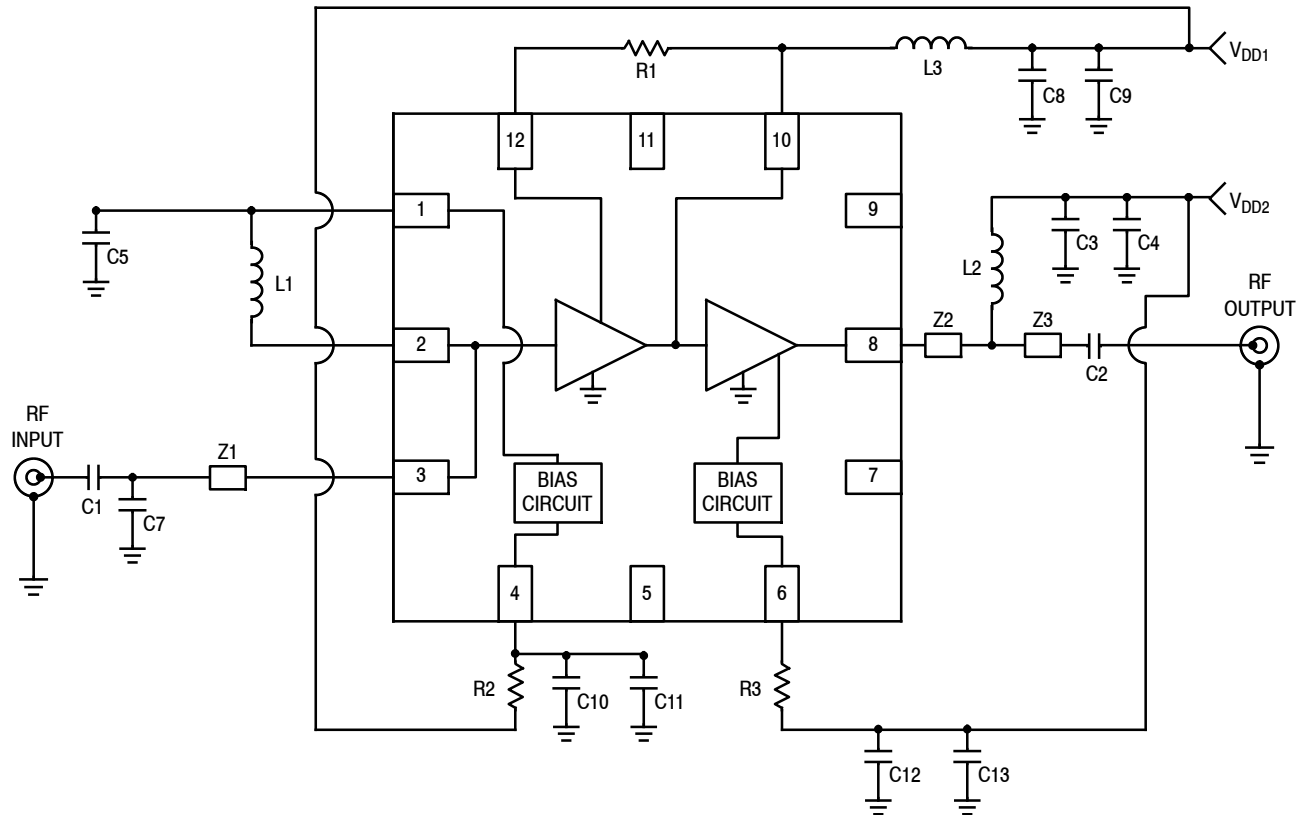
NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING & TOLERANCING PER ASME Y14.5 – 2009.
3. THIS DIMENSION APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. THIS DIMENSION APPLIED ONLY FOR TERMINALS.

|   |                          |                            |  |
|---|--------------------------|----------------------------|--|
| © FREESCALE SEMICONDUCTOR, INC.<br>ALL RIGHTS RESERVED.   | MECHANICAL OUTLINE       | PRINT VERSION NOT TO SCALE |  |
| TITLE:<br>THERMALLY ENHANCED QUAD<br>FLAT NON-LEADED PACKAGE (QFN)<br>12 TERMINAL, 0.5 PITCH (3X3X0.85) | DOCUMENT NO: 98ASA00227D | REV: 0                     |  |
|   | CASE NUMBER: 2131-01     | 14 MAY 2010                |  |
|   | STANDARD: NON-JEDEC      |                            |  |

## APPENDIX: APPLICATION CIRCUITS WITH TWO-SUPPLY VOLTAGE

### 50 OHM APPLICATION CIRCUIT: 1950 MHz



Z1 0.248" × 0.021" Microstrip  
 Z2 0.050" × 0.021" Microstrip  
 Z3 0.030" × 0.021" Microstrip

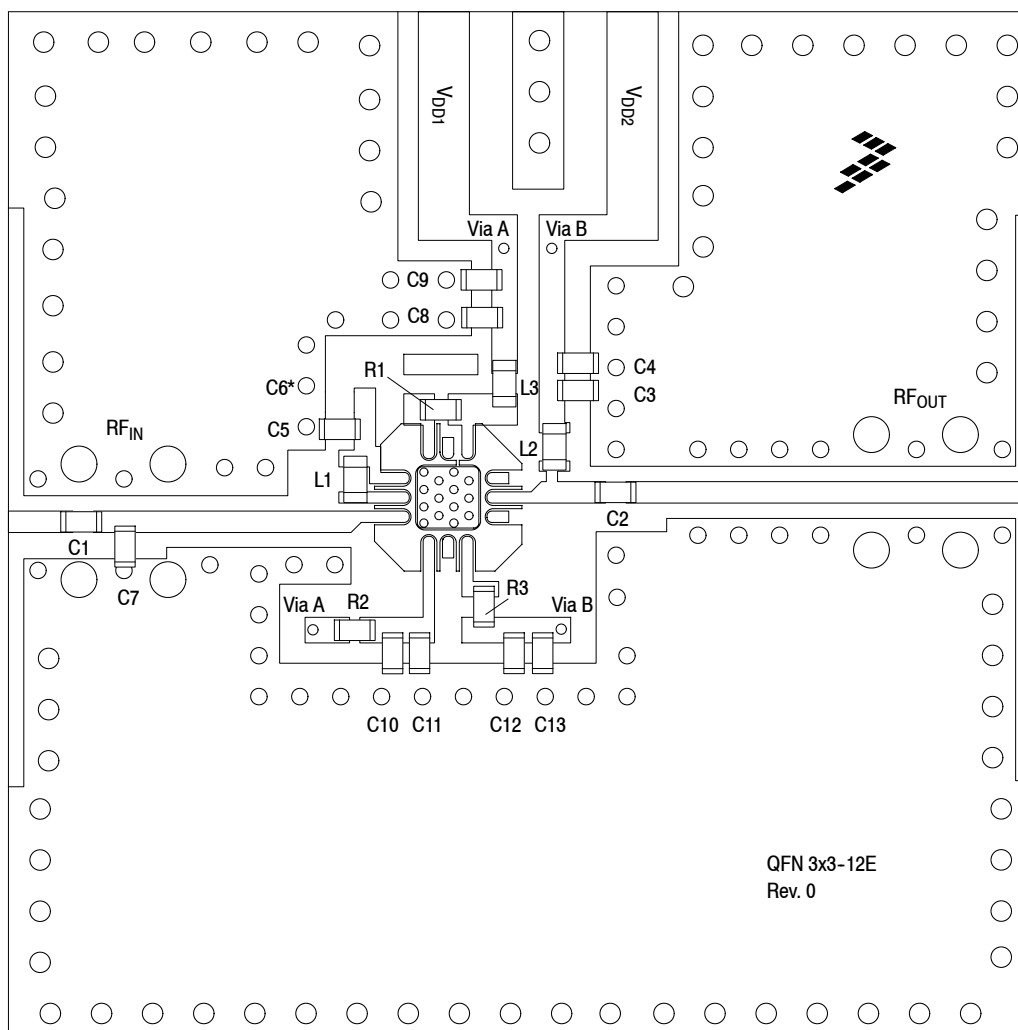
Figure A-1. MML20242HT1 Test Circuit Schematic

Table A-1. MML20242HT1 Test Circuit Component Designations and Values

| Part                 | Description                               | Part Number       | Manufacturer |
|----------------------|---|-------------------|--------------|
| C1, C5               | 18 pF Chip Capacitors                     | GJM1555C1H180GB01 | Murata       |
| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                     | GRM1555C1H180JA01 | Murata       |
| C4, C9, C10, C13     | 0.1 μF Chip Capacitors                    | GRM155R61A104K01  | Murata       |
| C6                   | Component Not Placed                      |                   |              |
| C7                   | 0.6 pF Chip Capacitor                     | GJM1555C1HR60WB01 | Murata       |
| L1                   | 3.3 nH Chip Inductor                      | 0402HP-3N3XJLW    | Coilcraft    |
| L2                   | 10 nH Chip Inductor                       | 0402CS-10NXJLW    | Coilcraft    |
| L3                   | 2.2 nH Chip Inductor                      | 0402CS-2N2XJLW    | Coilcraft    |
| R1                   | 180 Ω Chip Resistor                       | RC0402FR-07-180RL | Yageo        |
| R2, R3               | 1200 Ω Chip Resistors                     | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", ε <sub>r</sub> = 3.48, Multilayer | RO4350B           | Rogers       |

Note: Component number C6 is labeled on board but not placed.

50 OHM APPLICATION CIRCUIT: 1950 MHz



Note: Component number C6\* is labeled on board but not placed.

Figure A-2. MML20242HT1 Test Circuit Component Layout

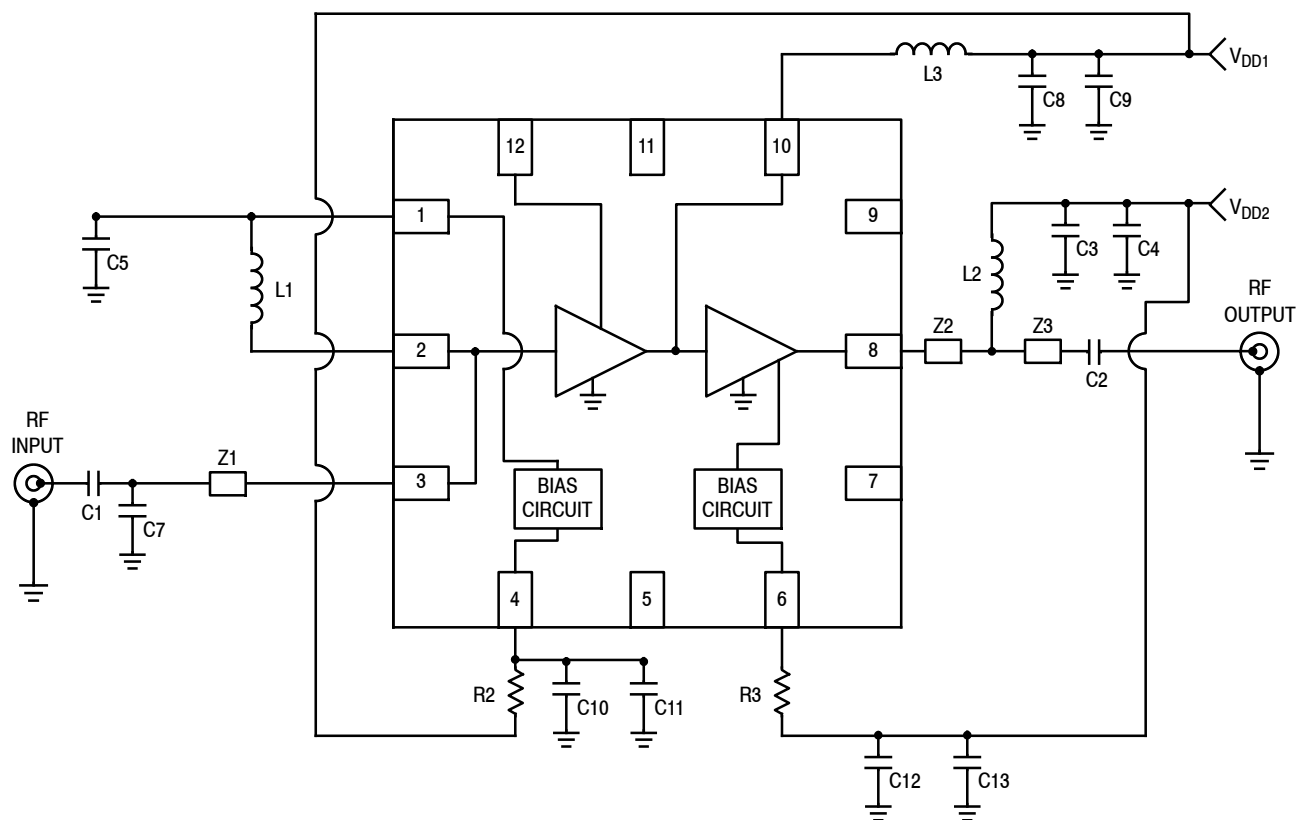
Table A-1. MML20242HT1 Test Circuit Component Designations and Values

| Part                 | Description                              | Part Number       | Manufacturer |
|----------------------|--|-------------------|--------------|
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| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                    | GRM1555C1H180JA01 | Murata       |
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| C7                   | 0.6 pF Chip Capacitor                    | GJM1555C1HR60WB01 | Murata       |
| L1                   | 3.3 nH Chip Inductor                     | 0402HP-3N3XJLW    | Coilcraft    |
| L2                   | 10 nH Chip Inductor                      | 0402CS-10NXJLW    | Coilcraft    |
| L3                   | 2.2 nH Chip Inductor                     | 0402CS-2N2XJLW    | Coilcraft    |
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| R2, R3               | 1200 $\Omega$ Chip Resistors             | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", $\epsilon_r = 3.48$ , Multilayer | RO4350B           | Rogers       |

(Test Circuit Component Designations and Values repeated for reference.)



50 OHM APPLICATION CIRCUIT: 2535 MHz



- Z1 0.248" × 0.021" Microstrip
- Z2 0.050" × 0.021" Microstrip
- Z3 0.030" × 0.021" Microstrip

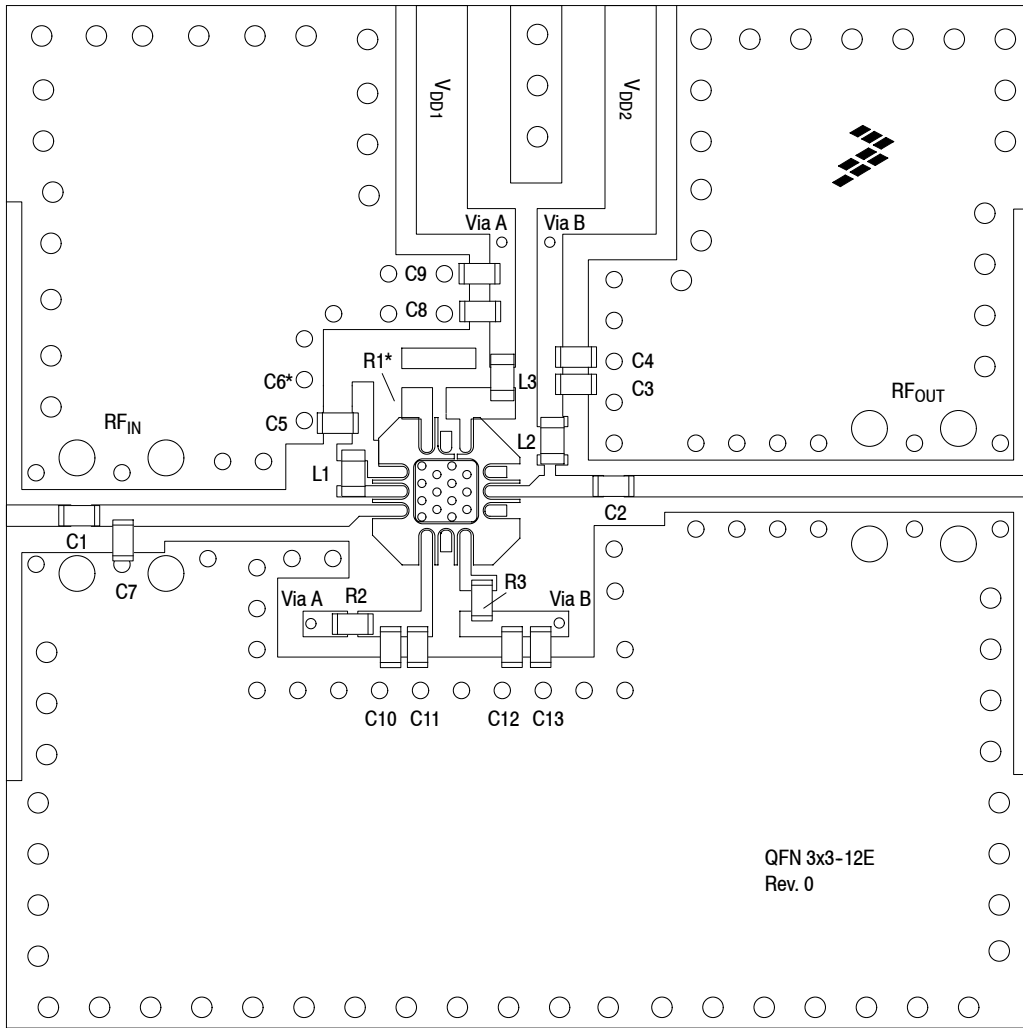
Figure A-3. MML20242HT1 Test Circuit Schematic

Table A-2. MML20242HT1 Test Circuit Component Designations and Values

| Part                 | Description                               | Part Number       | Manufacturer |
|----------------------|---|-------------------|--------------|
| C1, C5               | 18 pF Chip Capacitors                     | GJM1555C1H180GB01 | Murata       |
| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                     | GRM1555C1H180JA01 | Murata       |
| C4, C9, C10, C13     | 0.1 μF Chip Capacitors                    | GRM155R61A104K01  | Murata       |
| C6                   | Component Not Placed                      |                   |              |
| C7                   | 0.6 pF Chip Capacitor                     | GJM1555C1HR60WB01 | Murata       |
| L1                   | 2.7 nH Chip Inductor                      | 0402HP-2N7XJLW    | Coilcraft    |
| L2                   | 6.8 nH Chip Inductor                      | 0402CS-6N8XJLW    | Coilcraft    |
| L3                   | 1.0 nH Chip Inductor                      | 0402CS-1N0XJLW    | Coilcraft    |
| R1                   | Component Not Placed                      |                   |              |
| R2, R3               | 1200 Ω Chip Resistors                     | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", ε <sub>r</sub> = 3.48, Multilayer | RO4350B           | Rogers       |

Note: Component numbers C6 and R1 are labeled on board but not placed.

50 OHM APPLICATION CIRCUIT: 2535 MHz



Note: Component number C6\* and R1\* are labeled on board but not placed.

Figure A-4. MML20242HT1 Test Circuit Component Layout

Table A-2. MML20242HT1 Test Circuit Component Designations and Values

| Part                 | Description                              | Part Number       | Manufacturer |
|----------------------|--|-------------------|--------------|
| C1, C5               | 18 pF Chip Capacitors                    | GJM1555C1H180GB01 | Murata       |
| C2, C3, C8, C11, C12 | 18 pF Chip Capacitors                    | GRM1555C1H180JA01 | Murata       |
| C4, C9, C10, C13     | 0.1 $\mu$ F Chip Capacitors              | GRM155R61A104K01  | Murata       |
| C6                   | Component Not Placed                     |                   |              |
| C7                   | 0.6 pF Chip Capacitor                    | GJM1555C1HR60WB01 | Murata       |
| L1                   | 2.7 nH Chip Inductor                     | 0402HP-2N7XJLW    | Coilcraft    |
| L2                   | 6.8 nH Chip Inductor                     | 0402CS-6N8XJLW    | Coilcraft    |
| L3                   | 1.0 nH Chip Inductor                     | 0402CS-1N0XJLW    | Coilcraft    |
| R1                   | Component Not Placed                     |                   |              |
| R2, R3               | 1200 $\Omega$ Chip Resistors             | RC0402FR-07-1K2RL | Yageo        |
| PCB                  | 0.010", $\epsilon_r = 3.48$ , Multilayer | RO4350B           | Rogers       |

(Test Circuit Component Designations and Values repeated for reference.)

Refer to the following resources to aid your design process.

**Application Notes**

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers
- AN3100: General Purpose Amplifier and MMIC Biasing

**Software**

- .s2p File

**Development Tools**

- Printed Circuit Boards

For Software and Tools, do a Part Number search at <http://www.freescale.com>, and select the “Part Number” link. Go to Software & Tools on the part’s Product Summary page to download the respective tool.

**FAILURE ANALYSIS**

At this time, because of the physical characteristics of the part, failure analysis is limited to electrical signature analysis. In cases where Freescale is contractually obligated to perform failure analysis (FA) services, full FA may be performed by third party vendors with moderate success. For updates contact your local Freescale Sales Office.

**REVISION HISTORY**

The following table summarizes revisions to this document.

| Revision | Date       | Description   |
|----------|------------|---|
| 0        | Oct. 2012  | <ul style="list-style-type: none"> <li>• Initial Release of Data Sheet</li> </ul>   |
| 1        | Apr. 2013  | <ul style="list-style-type: none"> <li>• Features bullet for noise figure value: changed from 0.57 dB to 0.59 dB to reflect the true capability of the device, p. 1</li> <li>• Table 1, Typical Performance: changed 1950 MHz noise figure from 0.57 dB to 0.59 dB and 2800 MHz noise figure from 0.89 dB to 0.97 dB to reflect the true capability of the device, p. 1</li> <li>• Added 1950 MHz, 50 Ohm Operation, application circuit figures as follows:               <ul style="list-style-type: none"> <li>- Fig. 5, S11 versus Frequency versus Temperature, p. 5</li> <li>- Fig. 6, S12 versus Frequency versus Temperature, p. 5</li> <li>- Fig. 7, S21 versus Frequency versus Temperature, p. 5</li> <li>- Fig. 8, S22 versus Frequency versus Temperature, p. 5</li> <li>- Fig. 9, Noise Figure versus Frequency versus Temperature, p. 6</li> <li>- Fig. 10, Power Gain versus Output Power versus Temperature, CW, p. 6</li> <li>- Fig. 11, Third Order Output Intercept Point (Two-Tone) versus Frequency versus Temperature, p. 6</li> <li>- Fig. 12, P1dB versus Frequency versus Temperature, CW, p. 6</li> </ul> </li> <li>• Added 2535 MHz, 50 Ohm Operation, application circuit figures as follows:               <ul style="list-style-type: none"> <li>- Fig. 15, S11 versus Frequency, p. 9</li> <li>- Fig. 16, S12 versus Frequency, p. 9</li> <li>- Fig. 17, S21 versus Frequency, p. 9</li> <li>- Fig. 18, S22 versus Frequency, p. 9</li> <li>- Fig. 19, Noise Figure versus Frequency, p. 10</li> <li>- Fig. 20, Third Order Output Intercept Point (Two-Tone) versus Frequency, p. 10</li> </ul> </li> <li>• Added Appendix: Application Circuits with Two-Supply Voltage, pp. 15–18</li> </ul> |
| 2        | Sept. 2014 | <ul style="list-style-type: none"> <li>• Table 2, Maximum Ratings: added footnote to RF Input Power to indicate which test signal was used to derive the max ratings value and updated Junction Temperature from 150°C to 175°C to reflect recent test results of the device, p. 1</li> <li>• Added Failure Analysis information, p. 19</li> </ul>  |

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